Vishay Siliconix

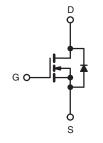


D Series Power MOSFET

PRODUCT SUMMA	RY		
V _{DS} (V) at T _J max.	450		
R _{DS(on)} max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.17	
Q _g max. (nC)	88		
Q _{gs} (nC)	12		
Q _{gd} (nC)	23		
Configuration	Sing	le	

TO-247AC





N-Channel MOSFET

FEATURES

- Halogen-free According to IEC 61249-2-21
 Definition
- Optimal Design
 - Low Area Specific On-Resistance
 - Low Input Capacitance (Ciss)
 - Reduced Capacitive Switching Losses
 - High Body Diode Ruggedness
 - Avalanche Energy Rated (UIS)
- Optimal Efficiency and Operation
 - Low Cost
 - Simple Gate Drive Circuitry
 - Low Figure-of-Merit (FOM): Ron x Qa
 - Fast Switching
- Compliant to RoHS Directive 2011/65/EU

APPLICATIONS

- Consumer Electronics
 - Displays (LCD or Plasma TV)
- Lighting
- Industrial
 - Welding
 - Induction Heating
 - Motor Drives
 - Battery Chargers
- SMPS

ORDERING INFORMATION	
Package	TO-247AC
Lead (Pb)-free	SiHG25N40D-E3
Lead (Pb)-free and Halogen-free	SiHG25N40D-GE3

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unless otherwis	se noted)		
PARAMETER	SYMBOL	LIMIT	UNIT	
Drain-Source Voltage	V _{DS}	400		
Gate-Source Voltage		N/	± 30	V
Gate-Source Voltage AC (f > 1 Hz)		V _{GS}	30	
Continuous Drain Current (T ₁ = 150 °C)	V_{GS} at 10 V $T_C = 25 \degree C$	1-	25	
$T_{C} = 100$		I _D	16	А
Pulsed Drain Current ^a		I _{DM}	78	
Linear Derating Factor			2.2	W/°C
Single Pulse Avalanche Energyb		E _{AS}	556	mJ
Maximum Power Dissipation		PD	278	W
Operating Junction and Storage Temperature Range	e	T _J , T _{stg}	- 55 to + 150	°C
Drain-Source Voltage Slope T _J = 125 °C		dV/dt	24	V/ns
Reverse Diode dV/dtd		uv/di	0.6	v/ns
Soldering Recommendations (Peak Temperature)	for 10 s		300 ^c	°C

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 2.3 mH, R_g = 25 Ω , I_{AS} = 17 A.

c. 1.6 mm from case.

d. $I_{SD} \le I_D$, starting $T_J = 25$ °C.

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1 stions contact: byn Document Number: 91484

For technical questions, contact: <u>hvm@vishay.com</u>



COMPLIANT

HALOGEN

Available

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PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-		40			0000	
Maximum Junction-to-Case (Drain)	R _{thJC}	-		0.45			°C/W	
		·						
SPECIFICATIONS (T _J = 25 °C, u	nless otherwi	ise noted)						
PARAMETER	SYMBOL	TES	T CONDITI	ONS	MIN.	TYP.	MAX.	UNIT
Static								<u> </u>
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} :	= 0 V, I _D = 2	250 µA	400	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I	_D = 250 μA	-	0.5	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$		3	-	5	V	
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 30	V	-	-	± 100	nA
	_	V _{DS} =	= 400 V, V _G	_S = 0 V	-	-	1	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 320 \	/, V _{GS} = 0 V	′, T _J = 125 °C	-	-	10	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	١ _c	₀ = 13 A	-	0.14	0.17	Ω
Forward Transconductance	9 _{fs}	V _{DS}	= 50 V, I _D =	= 13 A	-	7.4	-	S
Dynamic								1
Input Capacitance	C _{iss}		V _{GS} = 0 V		-	1707	-	
Output Capacitance	C _{oss}	1	$V_{DS} = 100$ V	ν,	-	177	-	pF
Reverse Transfer Capacitance	C _{rss}		f = 1 MHz		-	19	-	
Total Gate Charge	Qg				-	44	88	
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 V$	I _D = 13 /	A, V _{DS} = 320 V	-	12	-	nC
Gate-Drain Charge	Q _{ad}				-	23	-	1
Turn-On Delay Time	t _{d(on)}				-	21	42	
Rise Time	t _r		= 320 V, I _D =	- 12 A	-	57	86	
Turn-Off Delay Time	t _{d(off)}		10 V, R _q =		-	40	80	ns
Fall Time	t _f		9		-	37	74	1
Gate Input Resistance	Rg	f = 1	MHz, oper	n drain	-	1.8	-	Ω
Drain-Source Body Diode Characteristic	S					•		•
Continuous Source-Drain Diode Current	I _S	MOSFET sym showing the	bol		-	-	24	
Pulsed Diode Forward Current	I _{SM}	integral revers p - n junction			-	-	78	A
Diode Forward Voltage	V _{SD}	T _J = 25 °C	C, I _S = 13 A	, V _{GS} = 0 V	-	-	1.2	V
Reverse Recovery Time	t _{rr}				-	353	-	ns
Reverse Recovery Charge	Q _{rr}		5 °C, I _F = I _S		-	4.4	-	μC
Reverse Recovery Current	I _{RRM}	ai/dt =	100 A/µs, \	$v_{\rm R} = 20 \text{ V}$	_	24	_	A

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

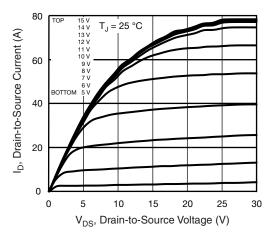


Fig. 1 - Typical Output Characteristics

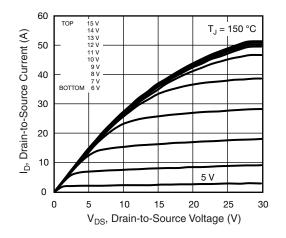


Fig. 2 - Typical Output Characteristics

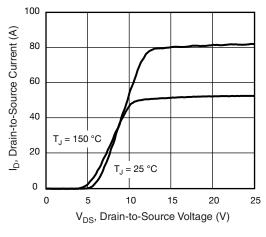


Fig. 3 - Typical Transfer Characteristics

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3 R_{DS(on)}, Drain-to-Source On Resistance (Normalized) 2.5 13 2 1.5 10 V = GS 0.5 0 - 60 - 40 -20 0 20 40 60 80 100 120 140 160 T_J, Junction Temperature (°C)

Fig. 4 - Normalized On-Resistance vs. Temperature

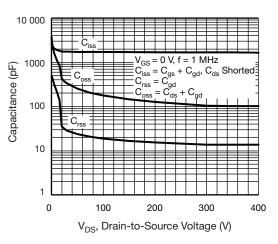
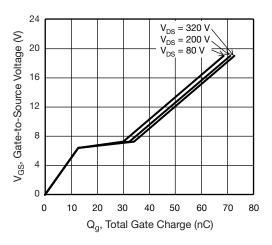


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





3 For technical questions, contact: <u>hvm@vishay.com</u>

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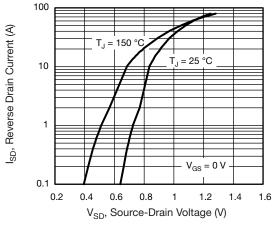
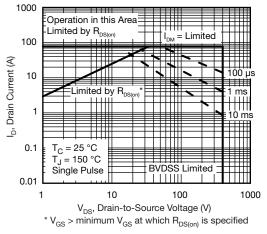
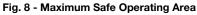


Fig. 7 - Typical Source-Drain Diode Forward Voltage





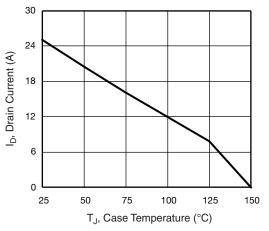


Fig. 9 - Maximum Drain Current vs. Case Temperature

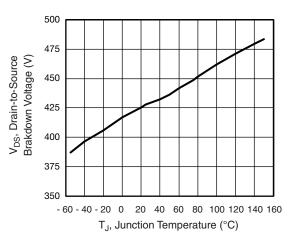
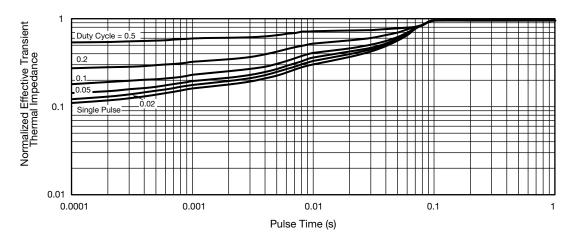


Fig. 10 - Temperature vs. Drain-to-Source Voltage





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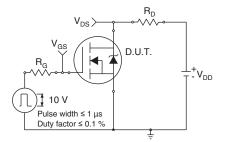


Fig. 12 - Switching Time Test Circuit



Fig. 13 - Switching Time Waveforms

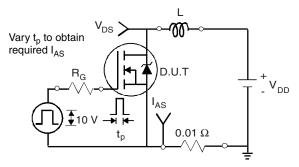


Fig. 14 - Unclamped Inductive Test Circuit

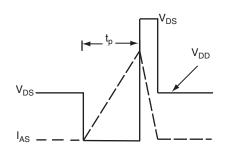
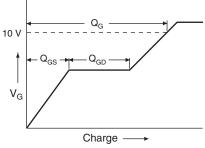


Fig. 15 - Unclamped Inductive Waveforms



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Fig. 16 - Basic Gate Charge Waveform

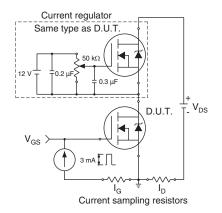


Fig. 17 - Gate Charge Test Circuit

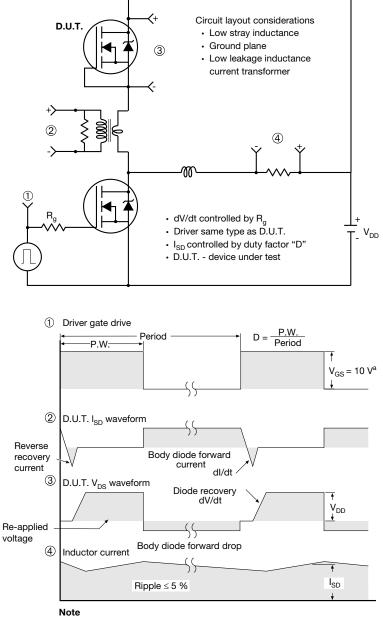
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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 18 - For N-Channel

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TO-247AC (High Voltage)

VERSION 1: FACILITY CODE = 9





Section C--C, D--D, E--E

1	 \

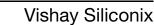
	MILLIN	IETERS	
DIM.	MIN.	MAX.	NOTES
А	4.83	5.21	
A1	2.29	2.55	
A2	1.50	2.49	
b	1.12	1.33	
b1	1.12	1.28	
b2	1.91	2.39	6
b3	1.91	2.34	
b4	2.87	3.22	6, 8
b5	2.87	3.18	
С	0.55	0.69	6
c1	0.55	0.65	
D	20.40	20.70	4

	MILLIN	IETERS	
DIM.	MIN.	MAX.	NOTES
D1	16.25	16.85	5
D2	0.56	0.76	
E	15.50	15.87	4
E1	13.46	14.16	5
E2	4.52	5.49	3
е	5.44	BSC	
L	14.90	15.40	
L1	3.96	4.16	6
ØΡ	3.56	3.65	7
Ø P1	7.19	7.19 ref.	
Q	5.31	5.69	
S	5.54	5.74	

Notes

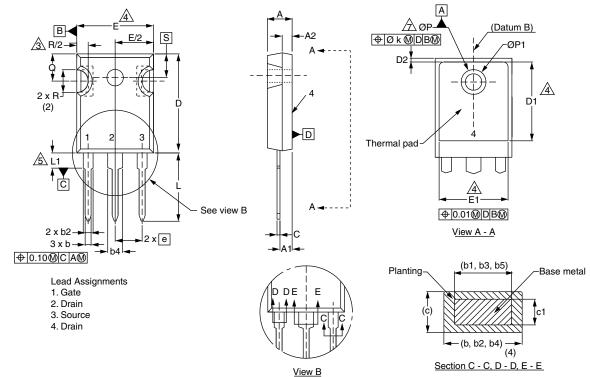
- ⁽¹⁾ Package reference: JEDEC[®] TO247, variation AC
- (2) All dimensions are in mm
- ⁽³⁾ Slot required, notch may be rounded
- ⁽⁴⁾ Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm per side. These dimensions are measured at the outermost extremes of the plastic body
- ⁽⁵⁾ Thermal pad contour optional with dimensions D1 and E1
- (6) Lead finish uncontrolled in L1
- (7) Ø P to have a maximum draft angle of 1.5° to the top of the part with a maximum hole diameter of 3.91 mm
- (8) Dimension b2 and b4 does not include dambar protrusion. Allowable dambar protrusion shall be 0.1 mm total in excess of b2 and b4 dimension at maximum material condition

Revision: 19-Oct-2020





VERSION 2: FACILITY CODE = Y



	MILLIN	IETERS	
DIM.	MIN.	MAX.	NOTES
А	4.58	5.31	
A1	2.21	2.59	
A2	1.17	2.49	
b	0.99	1.40	
b1	0.99	1.35	
b2	1.53	2.39	
b3	1.65	2.37	
b4	2.42	3.43	
b5	2.59	3.38	
С	0.38	0.86	
c1	0.38	0.76	
D	19.71	20.82	
D1	13.08	-	

	MILLIN	IETERS	
DIM.	MIN.	MAX.	NOTES
D2	0.51	1.30	
E	15.29	15.87	
E1	13.72	-	
е	5.46	BSC	
Øk	0.2	254	
L	14.20	16.25	
L1	3.71	4.29	
ØР	3.51	3.66	
Ø P1	-	7.39	
Q	5.31	5.69	
R	4.52	5.49	
S	5.51	BSC	

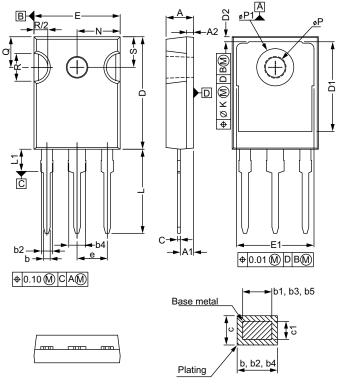
Notes

- ⁽¹⁾ Dimensioning and tolerancing per ASME Y14.5M-1994
- ⁽²⁾ Contour of slot optional
- (3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- ⁽⁴⁾ Thermal pad contour optional with dimensions D1 and E1
- ⁽⁵⁾ Lead finish uncontrolled in L1
- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- ⁽⁷⁾ Outline conforms to JEDEC outline TO-247 with exception of dimension c



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VERSION 3: FACILITY CODE = N



	MILLIN	IETERS		MILLIN	IETERS
DIM.	MIN.	MAX.	DIM.	MIN.	MAX.
А	4.65	5.31	D2	0.51	1.35
A1	2.21	2.59	E	15.29	15.87
A2	1.17	1.37	E1	13.46	-
b	0.99	1.40	е	5.46	BSC
b1	0.99	1.35	k	0.2	254
b2	1.65	2.39	L	14.20	16.10
b3	1.65	2.34	L1	3.71	4.29
b4	2.59	3.43	N	7.62	BSC
b5	2.59	3.38	Р	3.56	3.66
С	0.38	0.89	P1	-	7.39
c1	0.38	0.84	Q	5.31	5.69
D	19.71	20.70	R	4.52	5.49
D1	13.08	-	S	5.51	BSC

Notes

⁽¹⁾ Dimensioning and tolerancing per ASME Y14.5M-1994

⁽²⁾ Contour of slot optional

⁽³⁾ Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body

⁽⁴⁾ Thermal pad contour optional with dimensions D1 and E1

⁽⁵⁾ Lead finish uncontrolled in L1

⁽⁶⁾ Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")

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